

## ● General Description

The AGM065N10C combines advanced trench MOSFET technology with a low resistance package to provide extremely low  $R_{DS(ON)}$ .

This device is ideal for load switch and battery protection applications.

## ● Features

- Advance high cell density Trench technology
- Low  $R_{DS(ON)}$  to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance

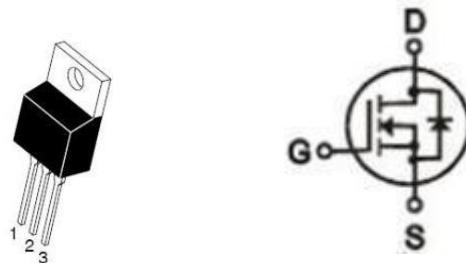
## ● Application

- MB/VGA Vcore
- SMPS 2<sup>nd</sup> Synchronous Rectifier
- POL application
- BLDC Motor driver

## Product Summary

| BVDSS | RDS(on) | ID   |
|-------|---------|------|
| 100V  | 6.2mΩ   | 100A |

## TO-220 Pin Configuration



## Package Marking and Ordering Information

| Device Marking | Device     | Device Package | Reel Size | Tape width | Quantity |
|----------------|------------|----------------|-----------|------------|----------|
| AGM065N10C     | AGM065N10C | TO-220         | ----      | ----       | 1000     |

Table 1. Absolute Maximum Ratings (TA=25°C)

| Symbol      | Parameter  | Value      | Unit |
|-------------|--|------------|------|
| VDS         | Drain-Source Voltage (VGS=0V)                            | 100        | V    |
| VGS         | Gate-Source Voltage (VDS=0V)                             | ±20        | V    |
| ID          | Drain Current-Continuous(Tc=25°C) <b>(Note 1)</b>        | 100        | A    |
|             | Drain Current-Continuous(Tc=100°C)                       | 63         | A    |
| IDM (pulse) | Drain Current-Continuous@ Current-Pulsed <b>(Note 2)</b> | 260        | A    |
| PD          | Maximum Power Dissipation(Tc=25°C)                       | 128        | W    |
|             | Maximum Power Dissipation(Tc=100°C)                      | 51         | W    |
| EAS         | Avalanche energy <b>(Note 3)</b>                         | 132        | mJ   |
| TJ,TSTG     | Operating Junction and Storage Temperature Range         | -55 To 150 | °C   |

Table 2. Thermal Characteristic

| Symbol           | Parameter   | Typ | Max  | Unit |
|------------------|---|-----|------|------|
| R <sub>θJA</sub> | Thermal Resistance Junction-ambient (Steady State) <sup>1</sup> | --- | 66   | °C/W |
| R <sub>θJC</sub> | Thermal Resistance Junction-Case <sup>1</sup>                   | --- | 0.97 | °C/W |

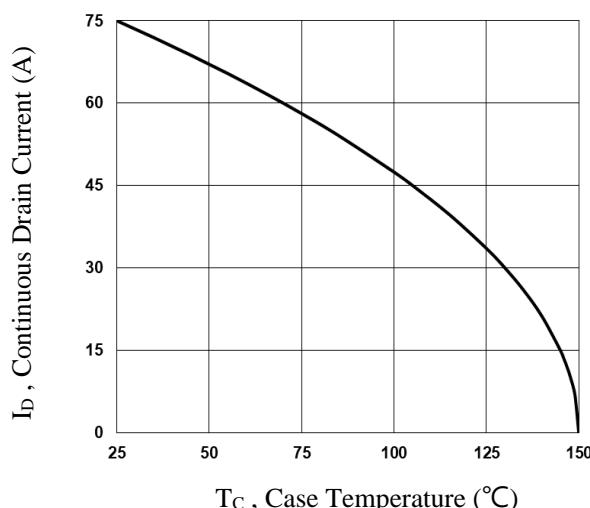
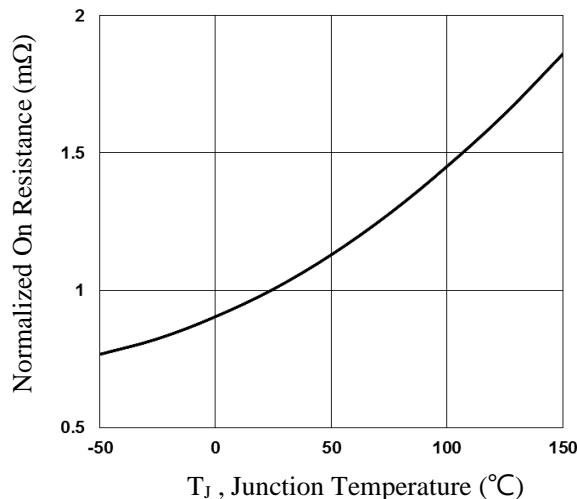
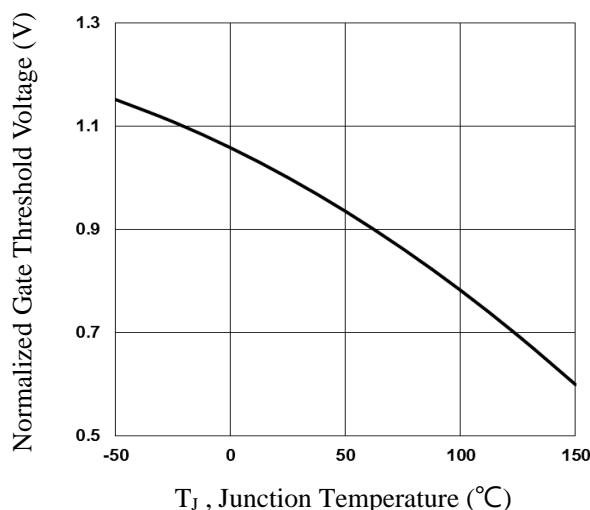
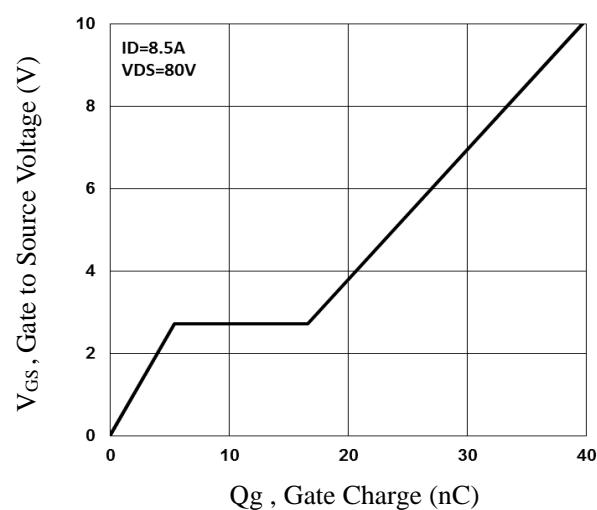
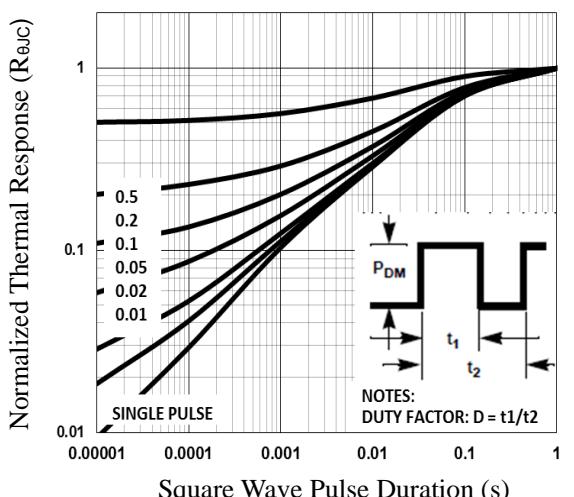
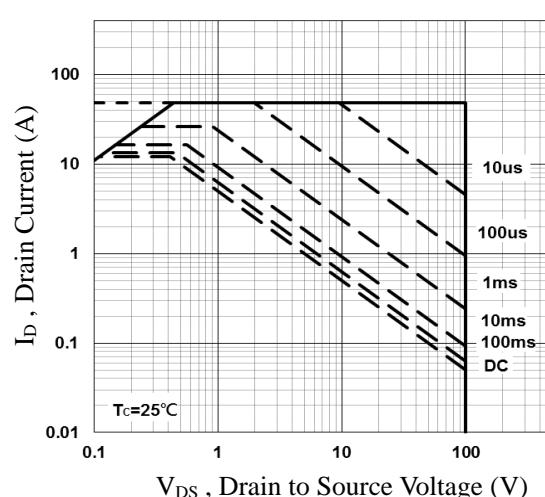
**Table 3. Electrical Characteristics (TA=25°C unless otherwise noted)**

| Symbol                                    | Parameter                        | Conditions                               | Min | Typ  | Max  | Unit |
|---|----------------------------------|--|-----|------|------|------|
| <b>On/Off States</b>                      |                                  |  |     |      |      |      |
| BVDSS                                     | Drain-Source Breakdown Voltage   | VGS=0V ID=250μA                          | 100 | --   | --   | V    |
| IDSS                                      | Zero Gate Voltage Drain Current  | VDS=100V, VGS=0V                         | --  | --   | 1    | μA   |
| IGSS                                      | Gate-Body Leakage Current        | VGS=±20V, VDS=0V                         | --  | --   | ±100 | nA   |
| VGS(th)                                   | Gate Threshold Voltage           | VDS=VGS, ID=250μA                        | 1.2 | 1.6  | 2.5  | V    |
| gFS                                       | Forward Transconductance         | VDS=5V, ID=10A                           | --  | --   | --   | S    |
| RDS(on)                                   | Drain-Source On-State Resistance | VGS=10V, ID=15A                          | --  | 6.2  | 7.6  | mΩ   |
|   |                                  | VGS=4.5V, ID=8.0A                        | --  | 8.0  | 10.4 | mΩ   |
| <b>Dynamic Characteristics</b>            |                                  |  |     |      |      |      |
| Ciss                                      | Input Capacitance                | VDS=50V, VGS=0V,<br>F=1MHZ               | --  | 1990 | --   | pF   |
| Coss                                      | Output Capacitance               |  | --  | 370  | --   | pF   |
| Crss                                      | Reverse Transfer Capacitance     |  | --  | 10   | --   | pF   |
| Rg  | Gate resistance                  | VGS=0V,<br>VDS=0V, f=1.0MHz              | --  | 1.2  | --   | Ω    |
| <b>Switching Times</b>                    |                                  |  |     |      |      |      |
| td(on)                                    | Turn-on Delay Time               | VGS=10V, VDS=50V,<br>ID=1A, RGEN=6Ω      | --  | 14.5 | --   | nS   |
| tr  | Turn-on Rise Time                |  | --  | 21.5 | --   | nS   |
| td(off)                                   | Turn-Off Delay Time              |  | --  | 54   | --   | nS   |
| tf  | Turn-Off Fall Time               |  | --  | 84   | --   | nS   |
| Qg  | Total Gate Charge                | VGS=10V, VDS=50V,<br>ID=8.5A             | --  | 39.5 | --   | nC   |
| Qgs                                       | Gate-Source Charge               |  | --  | 4.4  | --   | nC   |
| Qgd                                       | Gate-Drain Charge                |  | --  | 12.3 | --   | nC   |
| <b>Source-Drain Diode Characteristics</b> |                                  |  |     |      |      |      |
| ISD                                       | Source-Drain Current(Body Diode) |  | --  | --   | 100  | A    |
| VSD                                       | Forward on Voltage               | VGS=0V, IS=1A                            | --  | 0.7  | 1.2  | V    |
| trr                                       | Reverse Recovery Time            | IF=1A, VDD=50V<br>dI/dt=100A/μs, TJ=25°C | --  | --   | --   | ns   |
| Qrr                                       | Reverse Recovery Charge          |  | --  | --   | --   | nc   |

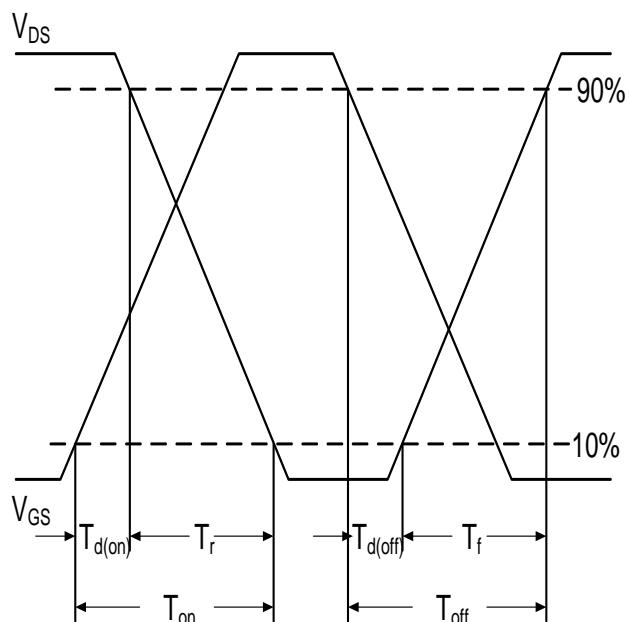
Notes 1.The maximum current rating is package limited.

Notes 2.Repetitive Rating: Pulse width limited by maximum junction temperature

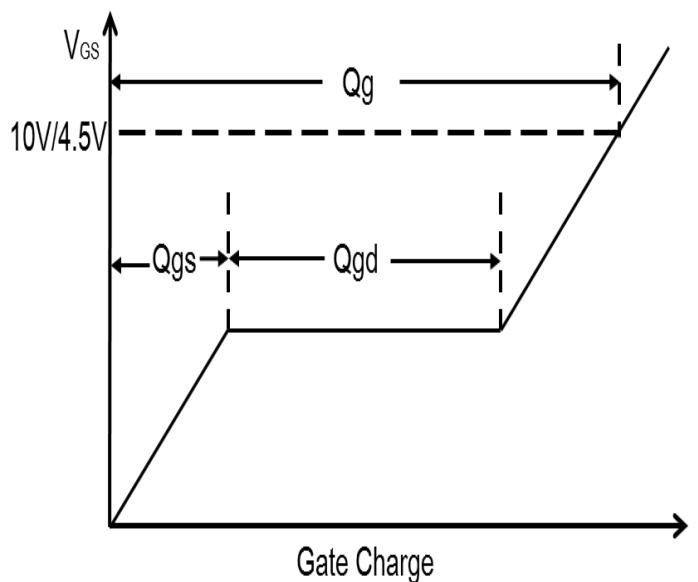
Notes 3.EAS condition: TJ=25°C

**Fig.1 Continuous Drain Current vs.  $T_C$** **Fig.2 Normalized RDSON vs.  $T_J$** **Fig.3 Normalized  $V_{th}$  vs.  $T_J$** **Fig.4 Gate Charge Characteristics****Fig.5 Normalized Transient Impedance****Fig.6 Maximum Safe Operation Area**

## TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

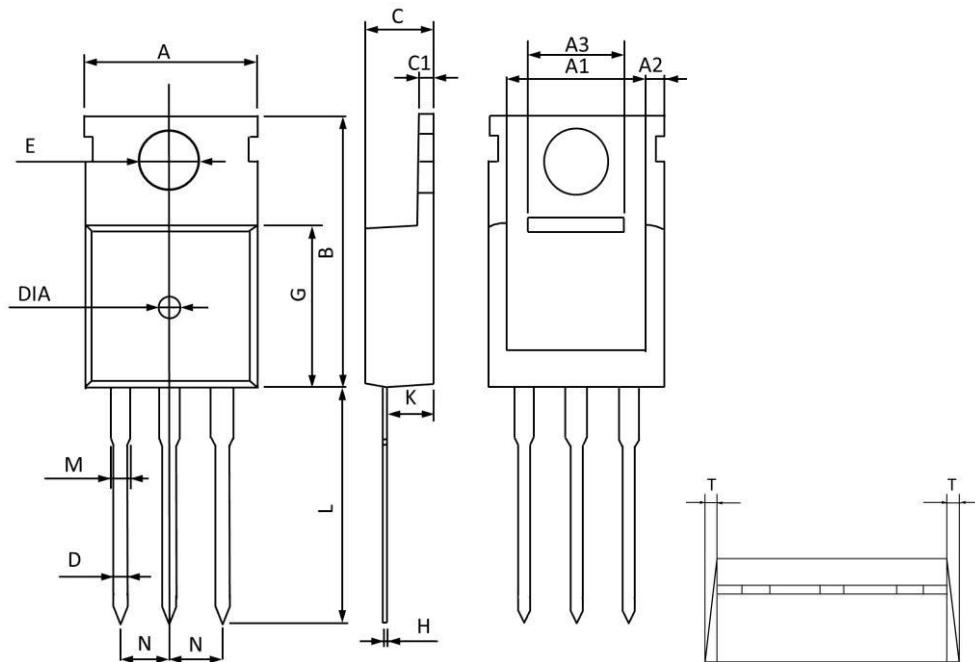


**Fig.7** Switching Time Waveform



**Fig.8** Gate Charge Waveform

## TO220 PACKAGE INFORMATION



| Symbol | Dimensions In Millimeters |              | Dimensions In Inches |                |
|--------|---------------------------|--------------|----------------------|----------------|
|        | MAX                       | MIN          | MAX                  | MIN            |
| A      | 10.300                    | 9.700        | 0.406                | 0.382          |
| A1     | 8.840                     | 8.440        | 0.348                | 0.332          |
| A2     | 1.250                     | 1.050        | 0.049                | 0.041          |
| A3     | 5.300                     | 5.100        | 0.209                | 0.201          |
| B      | 16.200                    | 15.400       | 0.638                | 0.606          |
| C      | 4.680                     | 4.280        | 0.184                | 0.169          |
| C1     | 1.500                     | 1.100        | 0.059                | 0.043          |
| D      | 1.000                     | 0.600        | 0.039                | 0.024          |
| E      | 3.800                     | 3.400        | 0.150                | 0.134          |
| G      | 9.300                     | 8.700        | 0.366                | 0.343          |
| H      | 0.600                     | 0.400        | 0.024                | 0.016          |
| K      | 2.700                     | 2.100        | 0.106                | 0.083          |
| L      | 13.600                    | 12.800       | 0.535                | 0.504          |
| M      | 1.500                     | 1.100        | 0.059                | 0.043          |
| N      | 2.590                     | 2.490        | 0.102                | 0.098          |
| T      | W0.35                     |              | W0.014               |                |
| DIA    | Φ1.5 TYP.                 | deep0.2 TYP. | Φ0.059 TYP.          | deep0.008 TYP. |

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